



**THE DATASHEET OF  
SMBJ5366B/TR13**

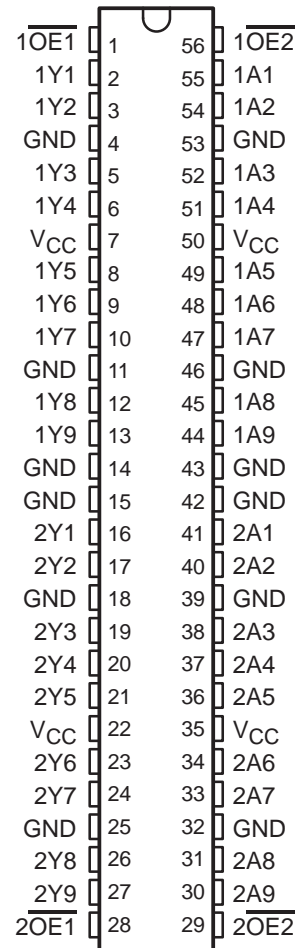


# SN54ABT16825, SN74ABT16825 18-BIT BUFFERS/DRIVERS WITH 3-STATE OUTPUTS

SCBS218D – JUNE 1992 – REVISED OCTOBER 2000

- Members of Texas Instruments' Widebus™ Family
- Latch-Up Performance Exceeds 500 mA Per JEDEC Standard JESD 17
- Typical  $V_{OLP}$  (Output Ground Bounce)  $<1$  V at  $V_{CC} = 5$  V,  $T_A = 25^\circ\text{C}$
- High-Impedance State During Power Up and Power Down
- Distributed  $V_{CC}$  and GND Pins Minimize High-Speed Switching Noise
- Flow-Through Architecture Optimizes PCB Layout
- High-Drive Outputs ( $-32\text{-mA } I_{OH}$ ,  $64\text{-mA } I_{OL}$ )

SN54ABT16825 ... WD PACKAGE  
SN74ABT16825 ... DL PACKAGE  
(TOP VIEW)



## description

The 'ABT16825 devices are 18-bit buffers and line drivers designed specifically to improve both the performance and density of 3-state memory address drivers, clock drivers, and bus-oriented receivers and transmitters. These devices can be used as two 9-bit buffers or one 18-bit buffer. They provide true data.

The 3-state control gate is a 2-input AND gate with active-low inputs so that, if either output-enable ( $\overline{OE1}$  or  $\overline{OE2}$ ) input is high, all nine affected outputs are in the high-impedance state.

When  $V_{CC}$  is between 0 and 2.1 V, the device is in the high-impedance state during power up or power down. However, to ensure the high-impedance state above 2.1 V,  $\overline{OE}$  should be tied to  $V_{CC}$  through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

## ORDERING INFORMATION

| $T_A$          | PACKAGE†  |               | ORDERABLE PART NUMBER | TOP-SIDE MARKING |
|----------------|-----------|---------------|-----------------------|------------------|
| -40°C to 85°C  | SSOP – DL | Tube          | SN74ABT16825DL        | ABT16825         |
|                |           | Tape and reel | SN74ABT16825DLR       |                  |
| -55°C to 125°C | CFP–WD    | Tube          | SNJ54ABT16825WD       | SNJ54ABT16825WD  |

† Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at [www.ti.com/sc/package](http://www.ti.com/sc/package).



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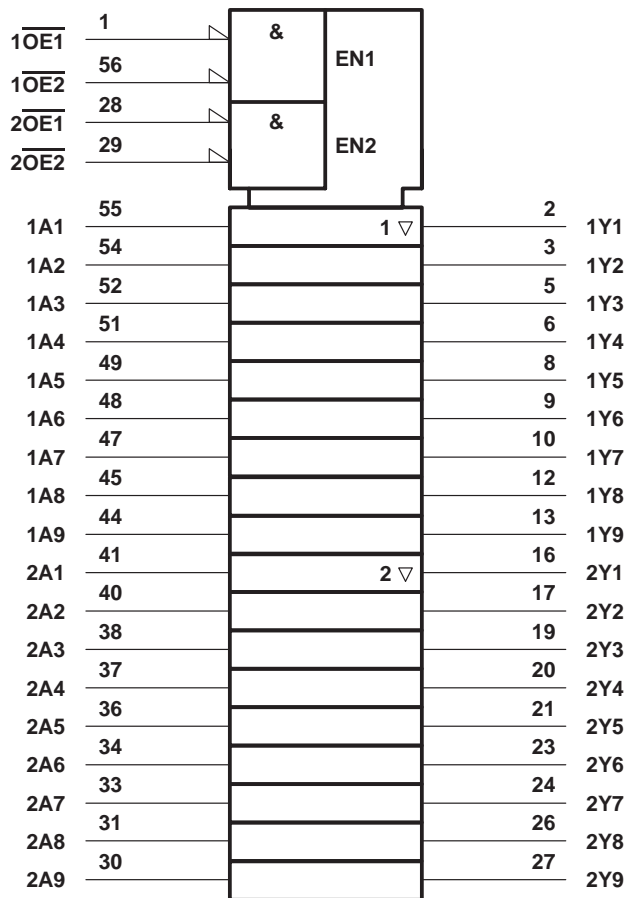
# SN54ABT16825, SN74ABT16825 18-BIT BUFFERS/DRIVERS WITH 3-STATE OUTPUTS

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FUNCTION TABLE  
(each 9-bit section)

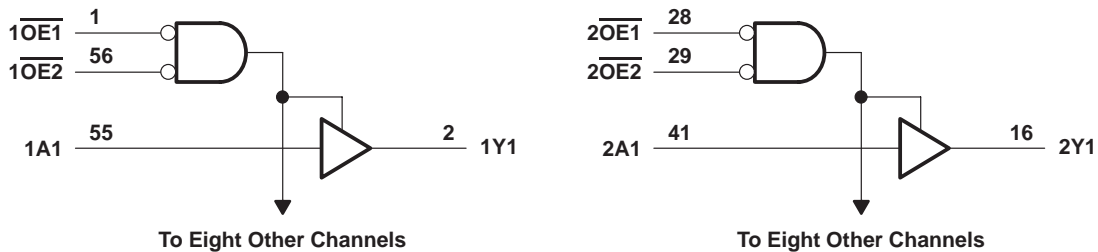
| INPUTS           |                  |   | OUTPUT<br>Y |
|------------------|------------------|---|-------------|
| $\overline{OE1}$ | $\overline{OE2}$ | A |             |
| L                | L                | L | L           |
| L                | L                | H | H           |
| H                | X                | X | Z           |
| X                | H                | X | Z           |

## logic symbol†



† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

## logic diagram (positive logic)



# SN54ABT16825, SN74ABT16825 18-BIT BUFFERS/DRIVERS WITH 3-STATE OUTPUTS

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## absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

|                                                                           |                 |
|---------------------------------------------------------------------------|-----------------|
| Supply voltage range, $V_{CC}$                                            | –0.5 V to 7 V   |
| Input voltage range, $V_I$ (see Note 1)                                   | –0.5 V to 7 V   |
| Voltage range applied to any output in the high or power-off state, $V_O$ | –0.5 V to 5.5 V |
| Current into any output in the low state, $I_O$ : SN54ABT16825            | 96 mA           |
| SN74ABT16825                                                              | 128 mA          |
| Input clamp current, $I_{IK}$ ( $V_I < 0$ )                               | –18 mA          |
| Output clamp current, $I_{OK}$ ( $V_O < 0$ )                              | –50 mA          |
| Package thermal impedance, $\theta_{JA}$ (see Note 2)                     | 56°C/W          |
| Storage temperature range, $T_{stg}$                                      | –65°C to 150°C  |

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.  
2. The package thermal impedance is calculated in accordance with JESD 51-7.

## recommended operating conditions (see Note 3)

|                          |                                    | SN54ABT16825 |          | SN74ABT16825 |          | UNIT      |
|--------------------------|------------------------------------|--------------|----------|--------------|----------|-----------|
|                          |                                    | MIN          | MAX      | MIN          | MAX      |           |
| $V_{CC}$                 | Supply voltage                     | 4.5          | 5.5      | 4.5          | 5.5      | V         |
| $V_{IH}$                 | High-level input voltage           | 2            |          | 2            |          | V         |
| $V_{IL}$                 | Low-level input voltage            |              | 0.8      |              | 0.8      | V         |
| $V_I$                    | Input voltage                      | 0            | $V_{CC}$ | 0            | $V_{CC}$ | V         |
| $I_{OH}$                 | High-level output current          |              | –24      |              | –32      | mA        |
| $I_{OL}$                 | Low-level output current           |              | 48       |              | 64       | mA        |
| $\Delta t/\Delta v$      | Input transition rise or fall rate | Control pins |          | 4            |          | ns/V      |
|                          |                                    | Data pins    |          | 10           |          |           |
| $\Delta t/\Delta V_{CC}$ | Power-up ramp rate                 | 200          |          | 200          |          | $\mu$ s/V |
| $T_A$                    | Operating free-air temperature     | –55          | 125      | –40          | 85       | °C        |

NOTE 3: All unused inputs of the device must be held at  $V_{CC}$  or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

# SN54ABT16825, SN74ABT16825

## 18-BIT BUFFERS/DRIVERS

### WITH 3-STATE OUTPUTS

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER                | TEST CONDITIONS                                                                    | T <sub>A</sub> = 25°C                                                                |      |      | SN54ABT16825 |       | SN74ABT16825 |      | UNIT |    |
|--------------------------|------------------------------------------------------------------------------------|--------------------------------------------------------------------------------------|------|------|--------------|-------|--------------|------|------|----|
|                          |                                                                                    | MIN                                                                                  | TYP† | MAX  | MIN          | MAX   | MIN          | MAX  |      |    |
| V <sub>IK</sub>          | V <sub>CC</sub> = 4.5 V, I <sub>I</sub> = -18 mA                                   |                                                                                      |      | -1.2 |              | -1.2  |              | -1.2 | V    |    |
| V <sub>OH</sub>          | V <sub>CC</sub> = 4.5 V, I <sub>OH</sub> = -3 mA                                   |                                                                                      |      | 2.5  |              | 2.5   |              | 2.5  | V    |    |
|                          | V <sub>CC</sub> = 5 V, I <sub>OH</sub> = -3 mA                                     |                                                                                      |      | 3    |              | 3     |              | 3    |      |    |
|                          | V <sub>CC</sub> = 4.5 V                                                            | I <sub>OH</sub> = -24 mA                                                             |      |      | 2            |       | 2            |      |      | 2  |
| I <sub>OH</sub> = -32 mA |                                                                                    |                                                                                      |      | 2*   |              |       |              | 2    |      |    |
| V <sub>OL</sub>          | V <sub>CC</sub> = 4.5 V                                                            | I <sub>OL</sub> = 48 mA                                                              |      |      |              | 0.55  |              | 0.55 | V    |    |
|                          |                                                                                    | I <sub>OL</sub> = 64 mA                                                              |      |      |              | 0.55* |              | 0.55 |      |    |
| V <sub>hys</sub>         |                                                                                    |                                                                                      |      | 100  |              |       |              |      | mV   |    |
| I <sub>I</sub>           | V <sub>CC</sub> = 0 to 5.5 V, V <sub>I</sub> = V <sub>CC</sub> or GND              |                                                                                      |      | ±1   |              | ±1    |              | ±1   | µA   |    |
| I <sub>OZPU</sub>        | V <sub>CC</sub> = 0 to 2.1 V, V <sub>O</sub> = 0.5 V to 2.7 V, $\overline{OE} = X$ |                                                                                      |      | ±50  |              | ±50   |              | ±50  | µA   |    |
| I <sub>OZPD</sub>        | V <sub>CC</sub> = 2.1 V to 0, V <sub>O</sub> = 0.5 V to 2.7 V, $\overline{OE} = X$ |                                                                                      |      | ±50  |              | ±50   |              | ±50  | µA   |    |
| I <sub>OZH</sub>         | V <sub>CC</sub> = 2.1 V to 5.5 V, V <sub>O</sub> = 2.7 V, $\overline{OE} \geq 2$ V |                                                                                      |      | 10   |              | 10    |              | 10   | µA   |    |
| I <sub>OZL</sub>         | V <sub>CC</sub> = 2.1 V to 5.5 V, V <sub>O</sub> = 0.5 V, $\overline{OE} \geq 2$ V |                                                                                      |      | -10  |              | -10   |              | -10  | µA   |    |
| I <sub>off</sub>         | V <sub>CC</sub> = 0, V <sub>I</sub> or V <sub>O</sub> ≤ 4.5 V                      |                                                                                      |      | ±100 |              |       |              | ±100 | µA   |    |
| I <sub>CEX</sub>         | Outputs high                                                                       | V <sub>CC</sub> = 5.5 V, V <sub>O</sub> = 5.5 V                                      |      |      |              | 50    |              | 50   | µA   |    |
| I <sub>O‡</sub>          |                                                                                    | V <sub>CC</sub> = 5.5 V, V <sub>O</sub> = 2.5 V                                      | -50  | -100 | -180         | -50   | -180         | -50  | -180 | mA |
| I <sub>CC</sub>          | Outputs high                                                                       | V <sub>CC</sub> = 5.5 V, I <sub>O</sub> = 0, V <sub>I</sub> = V <sub>CC</sub> or GND |      |      |              | 2     |              | 2    | mA   |    |
|                          | Outputs low                                                                        |                                                                                      |      |      |              | 32    |              | 32   |      |    |
|                          | Outputs disabled                                                                   |                                                                                      |      |      |              | 2     |              | 2    |      |    |
| ΔI <sub>CC</sub> §       |                                                                                    | V <sub>CC</sub> = 5.5 V, One input at 3.4 V, Other inputs at V <sub>CC</sub> or GND  |      |      |              | 1.5   |              | 1.5  | mA   |    |
| C <sub>i</sub>           |                                                                                    | V <sub>I</sub> = 2.5 V or 0.5 V                                                      |      |      |              | 3     |              |      | pF   |    |
| C <sub>o</sub>           |                                                                                    | V <sub>O</sub> = 2.5 V or 0.5 V                                                      |      |      |              | 7.5   |              |      | pF   |    |

\* On products compliant to MIL-PRF-38535, this parameter does not apply.

† All typical values are at V<sub>CC</sub> = 5 V.

‡ Not more than one output should be tested at a time, and the duration of the test should not exceed one second.

§ This is the increase in supply current for each input that is at the specified TTL voltage level rather than V<sub>CC</sub> or GND.

switching characteristics over recommended ranges of supply voltage and operating free-air temperature, C<sub>L</sub> = 50 pF (unless otherwise noted) (see Figure 1)

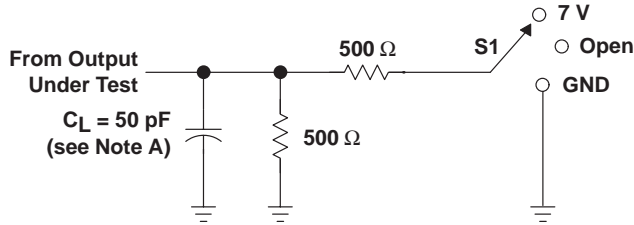
| PARAMETER        | FROM (INPUT)    | TO (OUTPUT) | V <sub>CC</sub> = 5 V, T <sub>A</sub> = 25°C |     |     | SN54ABT16825 |     | SN74ABT16825 |     | UNIT |
|------------------|-----------------|-------------|----------------------------------------------|-----|-----|--------------|-----|--------------|-----|------|
|                  |                 |             | MIN                                          | TYP | MAX | MIN          | MAX | MIN          | MAX |      |
| t <sub>PLH</sub> | A               | Y           | 1                                            | 1.9 | 3.6 | 1            | 4.1 | 1            | 3.9 | ns   |
| t <sub>PHL</sub> |                 |             | 1                                            | 2.1 | 3.9 | 1            | 4.7 | 1            | 4.4 |      |
| t <sub>PZH</sub> | $\overline{OE}$ | Y           | 1                                            | 2.8 | 5.5 | 1            | 6.4 | 1            | 6.1 | ns   |
| t <sub>PZL</sub> |                 |             | 1                                            | 2.8 | 5.4 |              | 6.3 | 1            | 6   |      |
| t <sub>PHZ</sub> | $\overline{OE}$ | Y           | 2.4                                          | 4.5 | 6.8 | 2.4          | 7.1 | 2.4          | 6.9 | ns   |
| t <sub>PLZ</sub> |                 |             | 1.6                                          | 3.7 | 6.2 | 1.6          | 7.6 | 1.6          | 6.6 |      |

PRODUCT PREVIEW information concerns products in the formative or design phase of development. Characteristic data and other specifications are design goals. Texas Instruments reserves the right to change or discontinue these products without notice.



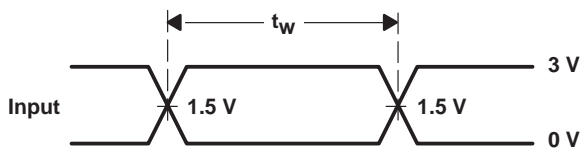
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PARAMETER MEASUREMENT INFORMATION

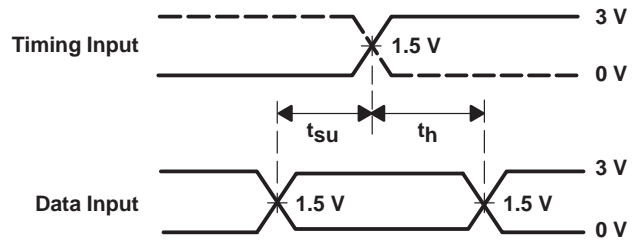


LOAD CIRCUIT

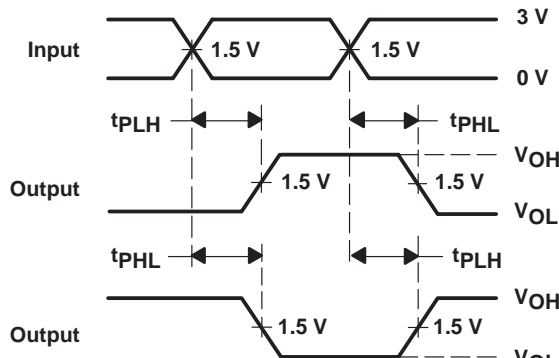
| TEST              | S1   |
|-------------------|------|
| $t_{PLH}/t_{PHL}$ | Open |
| $t_{PLZ}/t_{PZL}$ | 7 V  |
| $t_{PHZ}/t_{PZH}$ | Open |



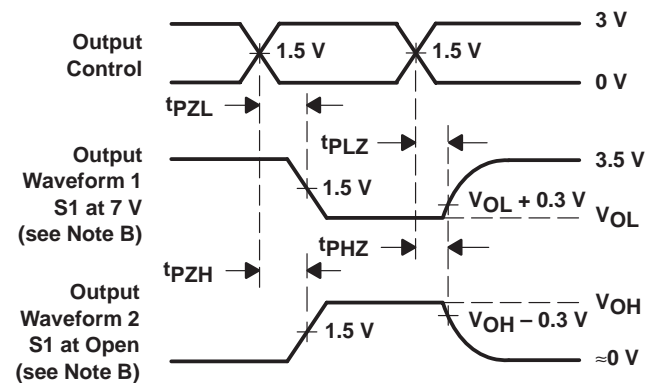
VOLTAGE WAVEFORMS  
PULSE DURATION



VOLTAGE WAVEFORMS  
SETUP AND HOLD TIMES



VOLTAGE WAVEFORMS  
PROPAGATION DELAY TIMES  
INVERTING AND NONINVERTING OUTPUTS



VOLTAGE WAVEFORMS  
ENABLE AND DISABLE TIMES  
LOW- AND HIGH-LEVEL ENABLING

- NOTES: A.  $C_L$  includes probe and jig capacitance.  
B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.  
C. All input pulses are supplied by generators having the following characteristics:  $PRR \leq 10 \text{ MHz}$ ,  $Z_O = 50 \Omega$ ,  $t_r \leq 2.5 \text{ ns}$ ,  $t_f \leq 2.5 \text{ ns}$ .  
D. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms

**PACKAGING INFORMATION**

| Orderable Device | Status<br>(1) | Package Type | Package Drawing | Pins | Package Qty | Eco Plan<br>(2) | Lead finish/<br>Ball material<br>(6) | MSL Peak Temp<br>(3) | Op Temp (°C) | Device Marking<br>(4/5) | Samples                 |
|------------------|---------------|--------------|-----------------|------|-------------|-----------------|--------------------------------------|----------------------|--------------|-------------------------|-------------------------|
| SN74ABT16825DL   | ACTIVE        | SSOP         | DL              | 56   | 20          | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 85    | ABT16825                | <a href="#">Samples</a> |
| SN74ABT16825DLR  | ACTIVE        | SSOP         | DL              | 56   | 1000        | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 85    | ABT16825                | <a href="#">Samples</a> |

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

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**OBSOLETE:** TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

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(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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**TAPE AND REEL INFORMATION**

**QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE**


\*All dimensions are nominal

| Device          | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|-----------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| SN74ABT16825DLR | SSOP         | DL              | 56   | 1000 | 330.0              | 32.4               | 11.35   | 18.67   | 3.1     | 16.0    | 32.0   | Q1            |

**TAPE AND REEL BOX DIMENSIONS**


\*All dimensions are nominal

| Device          | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|-----------------|--------------|-----------------|------|------|-------------|------------|-------------|
| SN74ABT16825DLR | SSOP         | DL              | 56   | 1000 | 367.0       | 367.0      | 55.0        |

**TUBE**



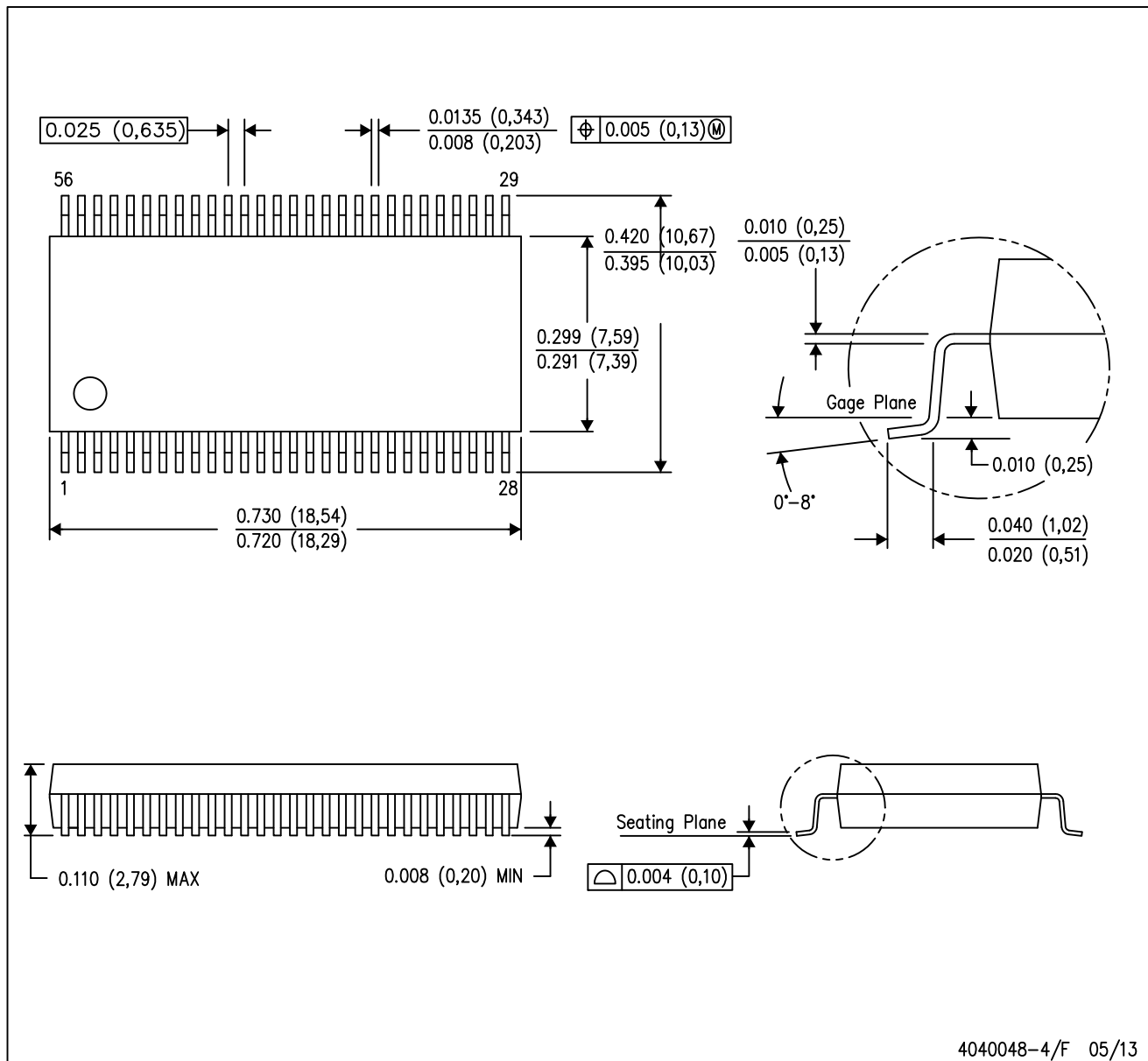
\*All dimensions are nominal

| Device         | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | T (μm) | B (mm) |
|----------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| SN74ABT16825DL | DL           | SSOP         | 56   | 20  | 473.7  | 14.24  | 5110   | 7.87   |

# MECHANICAL DATA

DL (R-PDSO-G56)

PLASTIC SMALL-OUTLINE PACKAGE



- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
  - D. Falls within JEDEC MO-118

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